

With respect to any product described in or for Attachment B to the Annex to the Ministerial Declaration on Trade in Information Technology Products (WT/MIN(96)/16), to the extent not specifically provided for in this Schedule, the customs duties on such product, as well any other duties and charges of any kind (within the meaning of Article II:1(b) of the General Agreement on Tariffs and Trade 1994), shall be bound and eliminated, as set forth in paragraph 2(a) of the Annex to the Declaration, wherever the product is classified.

<u>Description</u>	<u>HS</u>
Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	ex. 7017.10
Chemical vapor deposition apparatus for semiconductor production	ex. 8419.89
Parts of chemical vapor deposition apparatus for semiconductor production	ex. 8419.90
Apparatus for stripping or cleaning semiconductor wafers	ex. 8456.91
Lasercutters for cutting contacting tracks in semiconductor production by laser beam	ex. 8456.99
Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	ex. 8464.10
Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	ex. 8466.91
Parts of dicing machines for scribing or scoring semiconductor wafers	ex. 8466.91
Parts of lasercutters for cutting contacting tracks in semiconductor production by laser beam	ex. 8466.93
Parts of apparatus for stripping or cleaning semiconductor wafers	ex. 8466.93
Encapsulation equipment for assembly of semiconductors	ex. 8477.10
Parts of encapsulation equipment	ex. 8477.90
Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	ex. 8479.50
Apparatus for physical deposition by sputtering on semiconductor wafers	ex. 8479.89
Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	ex. 8479.89
Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	ex. 8479.89
Encapsulation equipment for assembly of semiconductors	ex. 8479.89
Machines for bending, folding and straightening semiconductor leads	ex. 8479.89
Physical deposition apparatus for semiconductor production	ex. 8479.89

<u>Description</u>	<u>HS</u>
Spinners for coating photographic emulsions on semiconductor wafers	ex. 8479.89
Part of apparatus for physical deposition by sputtering on semiconductor wafers	ex. 8479.90
Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	ex. 8479.90
Parts for spinners for coating photographic emulsions on semiconductor wafers	ex. 8479.90
Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	ex. 8479.90
Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	ex. 8479.90
Parts of encapsulation equipment for assembly of semiconductors	ex. 8479.90
Parts of machines for bending, folding and straightening semiconductor leads	ex. 8479.90
Parts of physical deposition apparatus for semiconductor production	ex. 8479.90
Apparatus for rapid heating of semiconductor wafers	ex. 8514.30
Parts of apparatus for rapid heating of wafers	ex. 8514.90
Wafer probers	ex. 8536.90
Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	ex. 8543.30
Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	ex. 8543.90
Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex. 9011.10
Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex. 9011.20
Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex. 9011.90
Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex. 9011.90

DescriptionHS

Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	9012.10
Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex. 9012.90
Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	ex. 9017.20
Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	ex. 9017.90
Parts of such pattern generating apparatus	ex. 9017.90
Computers: automatic data processing machines capable of 1) storing the processing program or programs and at least the data immediately necessary for the execution of the program; 2) being freely programmed in accordance with the requirements of the user	8471
Electric amplifiers when used as repeaters in line telephony products falling within this agreement, and parts thereof	ex. 8518
Flat panel display devices (including LCD, Electro Luminescence, Plasma, Vacuum Fluorescence and other technologies) for products falling within this agreement, and parts thereof.	8471.49,8471.60,8473.30,8531.20,ex8531.90,ex8543.89,ex8543.90
Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is	8471.90
Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals w	8471.60.200
Optical disc storage units, for automatic data processing machines (including CD drives and DVD-drives), whether or not having the capability of writing/recording as well as reading, whether or not in their own housings.	8471.70
Paging alert devices, and parts thereof .	ex. 8527.90
Plotters whether input or output units of HS heading No 8471 or drawing or drafting machines of HS heading No 9017.	ex. 8471.60.900
Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading	8471.50,8473.30,8473.50,8473.21,8473.29,8473.40,ex. 8504.40,8517.50,8517.90,8520.20,ex. 8529.90,8531.90,ex. 8543.90,9009.90,9026.90,ex. 9027.90,ex. 9030.90, ex. 9031.90

DescriptionHS

Projection type flat panel display units used with automatic data processing machines which can display digital information generated by the central processing unit. ex. 8525.40

Proprietary format storage devices including media therefor for automatic data processing machines, 8471.70,8471.49,8523.20,8523.90,8524.31,ex. 8524.39,8524.91,ex. 8524.99 with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units.

Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process ex. 8471.90

Set top boxes which have a communication function: a microprocessor-based device incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange ex. 8471.90